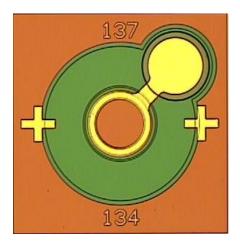


P/N: DO198 55um APD





# Introduction

This high performance product is a 2.5G APD (avalanche photodiode) chip that features a large 55µm front-side illuminated detection window for easy optical assembly. This product has an excellent reliability, low dark current at operating voltage, and high sensitivity up to -34dBm with a low-noise TIA. It is designed primarily to be used at 1310nm and 1490nm APD-TIA GPON applications that enable data transmission for today's fiber-to-thehome (FTTH) market.

# **Key Features**

- GCS proprietary design and process technologies
- 55µm optical detection window
- Backside common cathode and topside anode
- -34dBm typical sensitivity with low-noise TIA
- -25°C to 85°C operation range •
- High reliability with GCS robust 4" wafer manufacturing with fast cycle-time
- Deliverable in GCS Known Good Die<sup>™</sup> with 100% testing and inspection
- Customized layout dimensions available

## SPECIFICATIONS (T=25C<sup>o</sup>)

# **Applications**

- 2.5Gbps GPON receiver
- SONET OC48
- Ethernet

- **RoHS** compliant

	Conditions	Min.	Typical	Max.	Unit	Notes
Responsivity	1550 nm, M=1	-	0.87	-	A/W	
Gain	$V_{br}$ -2V, $P_o$ =1uW		9		-	
Breakdown voltage (V <sub>br</sub> )	I <sub>d</sub> =10uA, P <sub>o</sub> =1uW	38	45	50	V	
Temperature coefficient of V <sub>br</sub>	-45°C~+80°C	0.06	0.08	0.10	V/°C	
Dark current	V <sub>br</sub> -2V	-	1.3	20	nA	
Bandwidth	$V_{br}$ -2V, $P_o$ =1uW, 25°C	2.5	-	5	GHz	
Capacitance	V <sub>br</sub> -2V, f=1 MHz, 25°C	-	0.37	0.5	pF	
Wavelength Range		1200	1490	1600	nm	
Recommended operation bias			V <sub>br</sub> -2V		V	
Recommended alignment bias	25°C	$V = V_{br}-5V$		V		
Operating bias range (V <sub>br</sub> -V <sub>p</sub> )	25°C	20		V		

**Global Communication Semiconductors, LLC** 23155 Kashiwa Court, Torrance, CA 90505 Tel: (310) 530-7274 Fax: (310) 517-8200 e-mail: info@gcsincorp.com www.gcsincorp.com

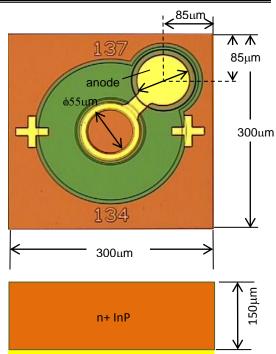


#### ABSOLUTE MAXIMUM RATING

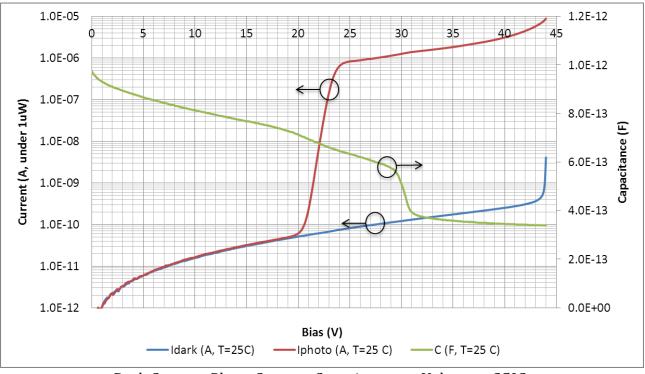
Parameter	Rating		
Operating Temperature	-25°C to 85°C		
Storage Temperature	-40°C to 125°C		
Soldering Temperature	260°C / 10 sec		
Forward Current	5mA		
Reverse Current	3mA		

#### DIMENSIONS

(Unit: um)	Min.	Typical	Max.
Detection window		55	
Bonding pad diameter		65	
Die height	140	150	160
Die width	290	300	310
Die length	290	300	310



backside cathode



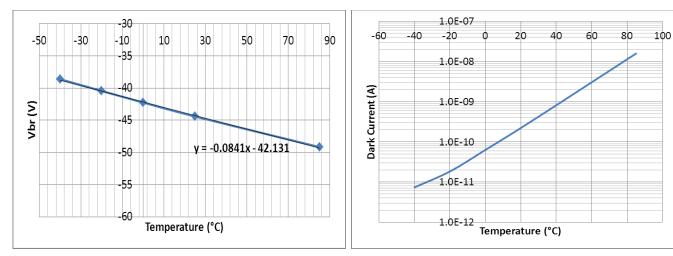
Typical Performance at 25°C

Dark Current, Photo Current, Capacitance vs. Voltage at 25°C

Global Communication Semiconductors, LLC 23155 Kashiwa Court, Torrance, CA 90505 Tel: (310) 530-7274 Fax: (310) 517-8200 e-mail: info@gcsincorp.com www.gcsincorp.com

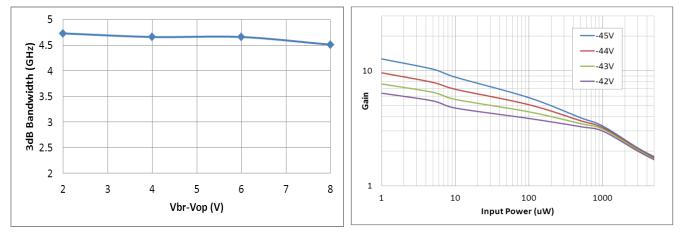
COPYRIGHT GLOBAL COMMUNICATION SEMICONDUCTORS LLC. ALL RIGHTS RESERVED.





Breakdown Voltage vs. Temperature

Dark Current (at V<sub>br</sub>-3V) vs. Temperature



Bandwidth vs. Operating Voltage (25°C)

Gain vs. Input Power (25°C)

## About GCS:

GCS has a long history manufacturing and shipping both GaAs and InGaAs based photo diodes since 2000. Our state of art manufacturing facility is located in Torrance, California, and has about 10,000 square feet of fab space with a capability of about 1200 4-inch wafers per month and expandable to 2000 wafers per month. GCS as a world-class semiconductor device manufacturer has been delivering a total of over 30 million photo diodes with various date rates and applications used for optical communications, which have been deployed in field by top tier optical transceiver companies worldwide.

Global Communication Semiconductors, LLC 23155 Kashiwa Court, Torrance, CA 90505 Tel: (310) 530-7274 Fax: (310) 517-8200 e-mail: info@gcsincorp.com www.gcsincorp.com

COPYRIGHT GLOBAL COMMUNICATION SEMICONDUCTORS LLC. ALL RIGHTS RESERVED.